

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese





FPF2C8P2NL07A F2, 3-phase, 3-level NPC module with Press-fit / NTC

General Description

Fairchild's new inverter modules provide low conduction and switching loss as well. And Press-Fit technology provides simple and reliable mounting. These modules are optimized for the applications such as solar inverter and UPS where a high efficiency and robust design is needed.

Electrical Features

- High Efficiency
- Low Conduction and Switching Losses
- Field Stop IGBT for Inner and Outer Switch
- STEALTHTM Diode for Path Diode
- Built-in NTC for Temperature Monitoring

Mechanical Features

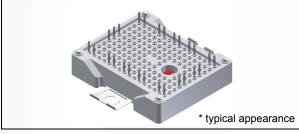
- Compact Size : F2 Package
- Press-fit Contact Technology
- Al₂O₃ Substrate with Low Thermal Resistance

Applications

- Solar Inverter
- UPS

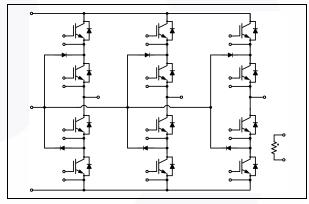
Related Materials

 AN-4167: Mounting Guideline for F1 / F2 Modules with Press-Fit Pins



June 2015

Package Code: F2



Internal Circuit Diagram

Package Marking and Ordering Information

Device	Device Marking	Package	Packing Type	Quantity / Tray
FPF2C8P2NL07A	FPF2C8P2NL07A	F2	Tray	14

Symbol	Descr	iption	Rating	Units
Outer IGBT	(Q1, Q4, Q5, Q8, Q9, Q12)			
V _{CES}	Collector-Emitter Voltage		650	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Continuous Collector Current	@ T _C = 80 °C, T _{Jmax} = 175 °C	30	A
I _{CM}	Pulsed Collector Current	limited by T _{Jmax}	60	A
P _D	Maximum Power Dissipation	@ T _C = 25 °C	135	W
TJ	Operating Junction Temperature		- 40 to + 150	°C
Inner IGBT	(Q2, Q3, Q6, Q7, Q10, Q11)			•
V _{CES}	Collector-Emitter Voltage		650	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Continuous Collector Current	@ T _C = 80 °C, T _{Jmax} = 175 °C	50	A
I _{CM}	Pulsed Collector Current	limited by T _{Jmax}	100	A
P _D	Maximum Power Dissipation	@ T _C = 25 °C	174	W
TJ	Operating Junction Temperature		- 40 to + 150	°C
Outer - Inne	er IGBT Series Connection			
SCWT	Short Circuit Withstand Time	V_{DC} = 300 V, V_{GE} = 15 V T _C = 25 °C	4	μS
Diode				
V _{RRM}	Peak Repetitive Reverse Voltage		650	V
I _F	Continuous Forward Current	@ T _C = 80 °C, T _{Jmax} = 175 °C	15	A
I _{FM}	Maximum Forward Current		30	A
P _D	Maximum Power Dissipation	@ T _C = 25 °C	100	W
TJ	Operating Junction Temperature		- 40 to + 150	°C
Module				
T _{STG}	Storage Temperature		- 40 to + 125	°C
V _{ISO}	Isolation Voltage	@ AC 1 min.	2500	V
IsoMaterial	Internal Isolation Material		Al ₂ O ₃	
T _{MOUNT}	Mounting Torque		2.0 to 5.0	Nm
Creepage	Terminal to Heat Sink		11.5	mm
	Terminal to Terminal		6.3	mm
Clearance	Terminal to Heat Sink		10.0	mm
	Terminal to Terminal		5.0	mm

2

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Outer IGE	р ЭТ	-	ļ			
Off Charac	teristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	650	-	-	V
I _{CES}	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	Gate-Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	2	μΑ
On Charac						•
V _{GE(th)}	Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 30 \text{ mA}$	4.5	5.6	6.7	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C = 30 A, V _{GE} = 15 V	-	1.55	2.2	V
()	-	$I_{C} = 30 \text{ A}, V_{GE} = 15 \text{ V} @T_{C} = 125 \text{ °C}$	-	1.75	-	V
		I _C = 60 A, V _{GE} = 15 V	-	2.13	-	V
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	33	-	ns
t _r	Rise Time	$I_{\rm C} = 30 {\rm A}$	-	43	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GE} = ± 15 V R _G = 20 Ω	-	197	-	ns
t _f	Fall Time	Inductive Load	-	17	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	T _C = 25 °C	-	0.68	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.38	-	mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	29	-	ns
t _r	Rise Time	$I_{\rm C} = 30 {\rm A}$	-	50	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GE} = ± 15 V R _G = 20 Ω	-	205	-	ns
t _f	Fall Time	Inductive Load	-	25	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	T _C = 125 °C	-	0.86	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.52	-	mJ
Q _g	Total Gate Charge	V_{CC} = 300 V, I _C = 30 A, V _{GE} = ± 15 V	-	0.26	-	μC
R _{0JC}	Thermal Resistance of Junction to Case	per Chip	-	-	1.11	°C/W
Inner IGB	Т					
Off Charac						
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0 V, I_{C} = 1 mA$	650	-	_	V
I _{CES}	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
I _{GES}	Gate-Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	2	μΑ
On Charac		VGE VGES, VCE VV			2	μι
	Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 50$ mA	4.5	5.6	6.7	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_{\rm C} = 50 \text{ A}, V_{\rm GE} = 15 \text{ V}$	-	1.65	2.3	v
or(sar)	in the second	$I_{\rm C} = 50 \text{ A}, V_{\rm GE} = 15 \text{ V} @T_{\rm C} = 125 ^{\circ}\text{C}$	-	1.95	-	V
		$I_{\rm C} = 100 \text{ A}, V_{\rm GE} = 15 \text{ V}$	-	2.49	-	V
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	41	-	ns
t _r	Rise Time	I _C = 50 A	-	65	-	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GE} = \pm 15 V$	-	233	-	ns
t _f	Fall Time	$R_{G} = 15 \Omega$ Inductive Load	-	18	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	$T_{\rm C} = 25 ^{\circ}{\rm C}$	-	0.87	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.77	-	mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V	-	39	-	ns
t _r	Rise Time	I _C = 50 A	-	76	-	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GE} = \pm 15 V$	-	243	-	ns
t _f	Fall Time	R _G = 15 Ω Inductive Load	-	20	-	ns
E _{ON}	Turn-On Switching Loss per Pulse	$T_{\rm C}$ = 125 °C	-	0.99	-	mJ
E _{OFF}	Turn-Off Switching Loss per Pulse		-	0.93	-	mJ
Q _g	Total Gate Charge	V _{CC} = 300 V, I _C = 50 A, V _{GE} = ± 15 V	-	0.39	-	nC
- ` Y	Thermal Resistance of Junction to Case	per Chip	-	-	0.86	°C/W

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Diode			I			
V _{FM}	Diode Forward Voltage	I _F = 15 A	-	2.55	3.4	V
		I _F = 15 A @T _C = 125 °C	-	1.78	-	V
I _R	Reverse Leakage Current	V _R = 650 V	-	-	250	μA
t _{rr}	Reverse Recovery Time	$V_{R} = 300 V, I_{F} = 15 A$ $di_{F} / dt = 700 A/us$ $T_{C} = 25 °C$	-	23	-	ns
l _{rr}	Reverse Recovery Current		-	9.9	-	Α
Q _{rr}	Reverse Recovery Charge		-	113	-	nC
t _{rr}	Reverse Recovery Time	$V_R = 300 \text{ V}, I_F = 15 \text{ A}$ di _F / dt = 700 A/us	-	49	-	ns
l _{rr}	Reverse Recovery Current		-	15.2	-	Α
Q _{rr}	Reverse Recovery Charge	– T _C = 125 °C	-	366	-	nC
R _{0JC}	Thermal Resistance of Junction to Case	per Chip	-	-	1.44	°C/W
NTC_The	ermistor					
R _{NTC}	Rated Resistance	T _C = 25 °C	-	5.0	-	kΩ
		T _C = 100 °C	-	493	-	Ω
	Tolerance	T _C = 25 °C	- 5	-	+ 5	%
PD	Power Dissipation	T _C = 25 °C	-	-	20	mW
B _{Value}	B-Constant	B _{25/50}	-	3375	-	К
		B _{25/100}	-	3436	-	К



Tc = 125 °C

E

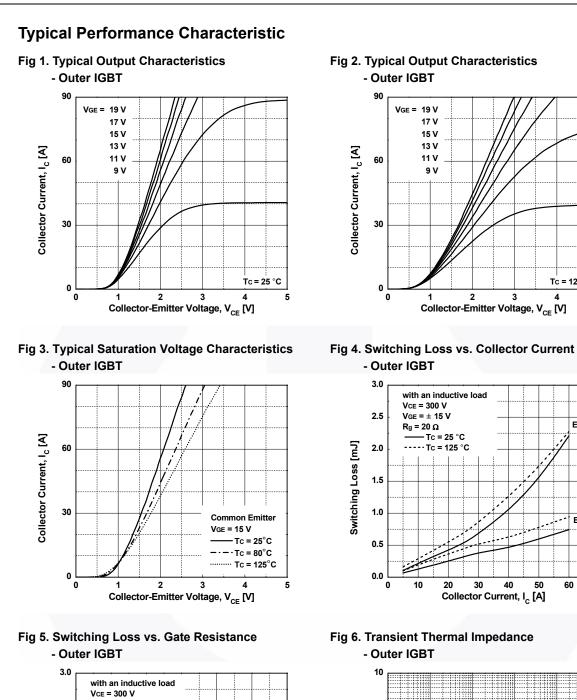
E

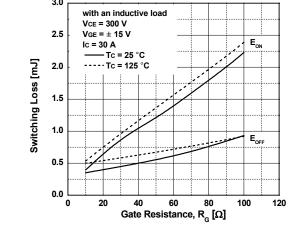
60

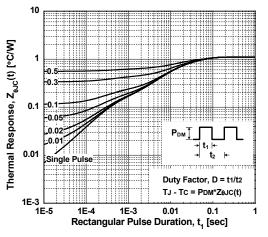
70

5

4







©2015 Fairchild Semiconductor Corporation FPF2C8P2NL07A Rev. 1.1

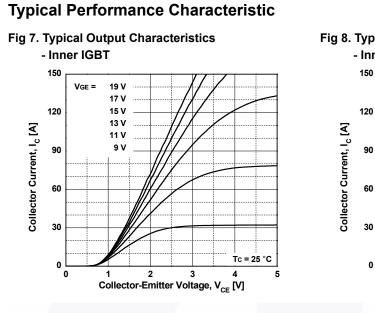
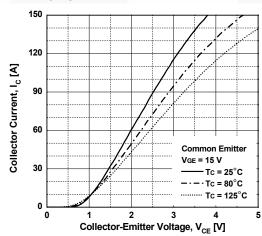
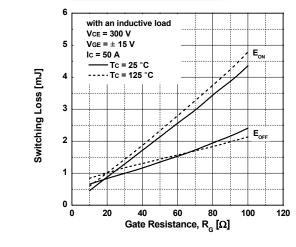
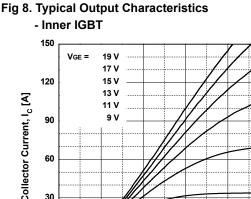


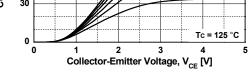
Fig 9. Typical Saturation Voltage Characteristics - Inner IGBT

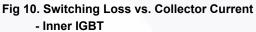


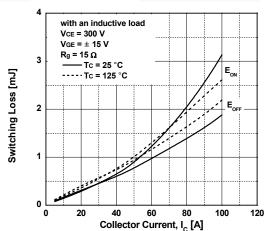


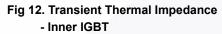


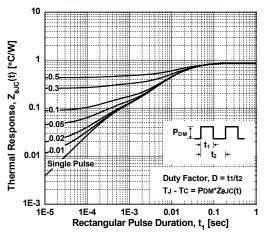


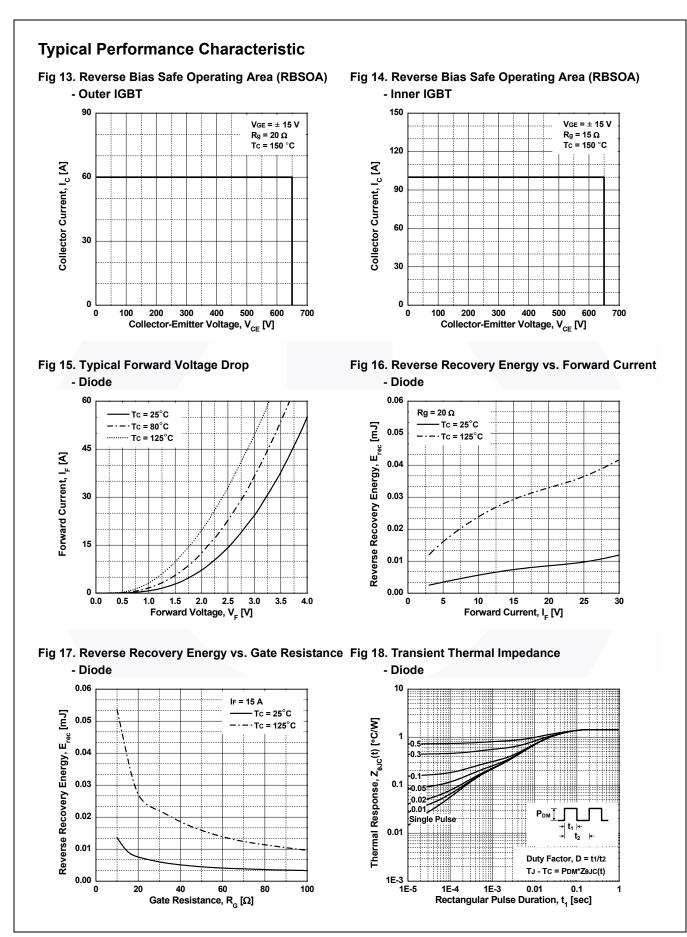




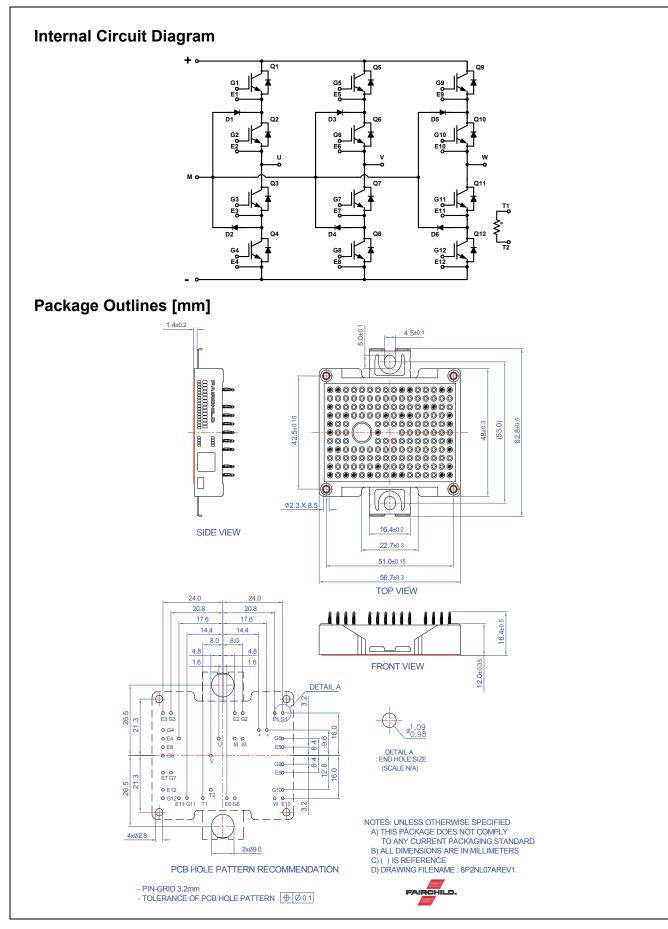








7





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly ori indirectly, any claim of personal injury or death

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for IGBT Modules category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

F3L400R07ME4_B22 F4-50R07W2H3_B51 FB15R06W1E3 FB20R06W1E3_B11 FD1000R33HE3-K FD400R12KE3 FD400R33KF2C-K FD401R17KF6C_B2 FD-DF80R12W1H3_B52 FF200R06YE3 FF300R12KE4_E FF450R12ME4P FF600R12IP4V FP15R12W2T4 FP20R06W1E3 FP50R12KT3 FP75R07N2E4_B11 FS10R12YE3 FS150R07PE4 FS150R12PT4 FS200R12KT4R FS20R06W1E3_B11 FS50R07N2E4_B11 FZ1000R33HE3 FZ1800R17KF4 DD250S65K3 DF1000R17IE4 DF1000R17IE4D_B2 DF1400R12IP4D DF200R12PT4_B6 DF400R07PE4R_B6 BSM75GB120DN2_E3223c-Se F3L300R12ME4_B22 F3L75R07W2E3_B11 F4-50R12KS4_B11 F475R07W1H3B11ABOMA1 FD1400R12IP4D FD200R12PT4_B6 FD800R33KF2C-K FF150R12ME3G FF300R17KE3_S4 FF300R17ME4_B11 FF401R17KF6C_B2 FF650R17IE4D_B2 FF900R12IP4D FF900R12IP4DV FP50R07N2E4_B11 FS100R07PE4 FS150R07N3E4_B11 FS150R17N3E4